



Lifecycle and Supply Chain Optimization in Industry 4.0

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Deadline for manuscript
submissions:

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Message from the Guest Editors

With adequate lifecycle management within various parts of the supply chain, it is evident that more transparent and efficient production can be achieved. Monitoring all of the elements of a smart factory can allow for proactive maintenance and production optimization; furthermore, advanced product lifecycle management can raise the user experience and can lead to greater customer satisfaction. This Special Issue aims to gather work related to supply chain and lifecycle management in general, especially in the aspect of Industry 4.0. Original and survey papers analyzing state-of-the-art in the area are also welcome. Reports on applications of existing models are interesting, as well as scientific achievements on the changes in current lifecycle management models, whether it is a change within a given model or possibly a description of how several lifecycle models can work together to achieve better lifecycle management. Furthermore, of course, it is particularly interesting to introduce research that presents new lifecycle models that did not exist before and were created to meet the changing needs brought about by Industry 4.0.





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Message from the Editor-in-Chief

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